

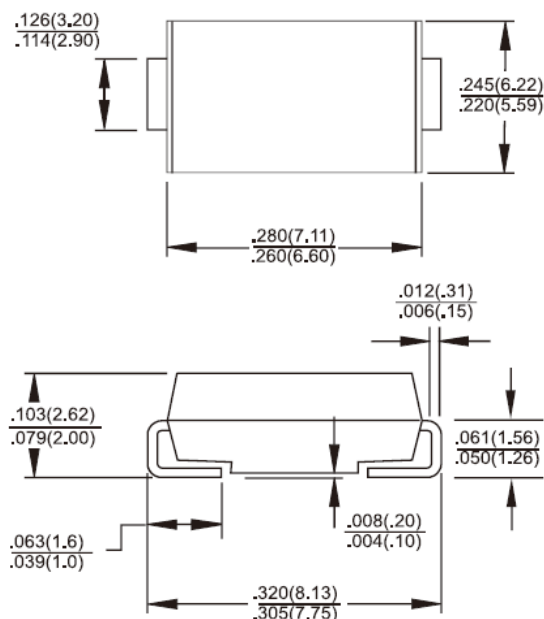


RoHS
COMPLIANCE



Features

- ✧ For surface mounted application
- ✧ Metal to silicon rectifier, majority carrier conduction
- ✧ Low forward voltage drop
- ✧ Easy pick and place
- ✧ High surge current capability
- ✧ Plastic material used carriers Underwriters Laboratory Classification 94V-0
- ✧ Epitaxial construction
- ✧ High temperature soldering:
260°C/10 seconds at terminals
- ✧ Green compound with suffix "G" on packing code & prefix "G" on datecode



Mechanical Data

- ✧ Case: Molded plastic
- ✧ Terminals: Solder plated
- ✧ Polarity: Indicated by cathode band
- ✧ Packaging: 16mm tape per EIA STD RS-481
- ✧ Weight: 0.21 grams

Dimensions in inches and (millimeters)

Marking Diagram



- SK8XC = Specific Device Code
G = Green Compound
Y = Year
M = Work Month

Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	SK 82C	SK 83C	SK 84C	SK 85C	SK 86C	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	20	30	40	50	60	V
Maximum RMS Voltage	V _{RMS}	20	30	40	50	60	V
Maximum DC Blocking Voltage	V _{DC}	14	21	28	35	42	V
Maximum Average Forward Rectified Current	I _{F(AV)}	8					A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	150					A
Maximum Instantaneous Forward Voltage (Note 1) @ 8 A	V _F	0.55			0.75		V
Maximum DC Reverse Current @ T _A =25 °C at Rated DC Blocking Voltage @ T _A =100 °C	I _R	0.5					mA
		15			10		mA
Typical Thermal Resistance	R _{θJA}	20					°C/W
Operating Temperature Range	T _J	-55 to +125			-55 to +150		°C
Storage Temperature Range	T _{STG}	- 55 to +150					°C

Note 1: Pulse Test with PW=300 usec, 1% Duty Cycle

RATINGS AND CHARACTERISTIC CURVES (SK82C THRU SK86C)

FIG. 1- MAXIMUM FORWARD CURRENT DERATING CURVE

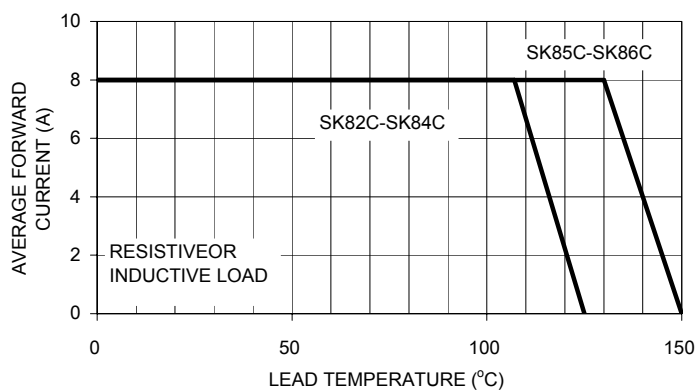


FIG. 2- MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

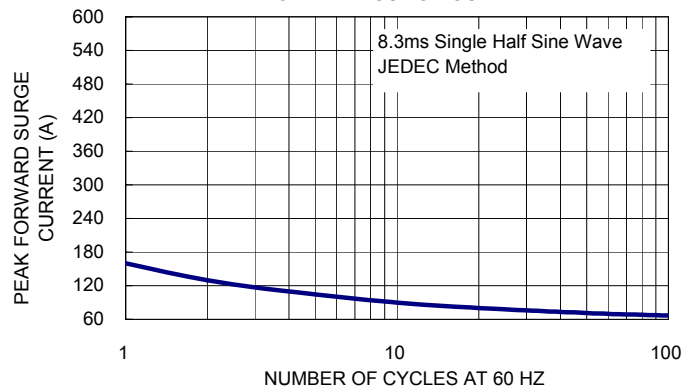


FIG. 3- TYPICAL FORWARD CHARACTERISTICS

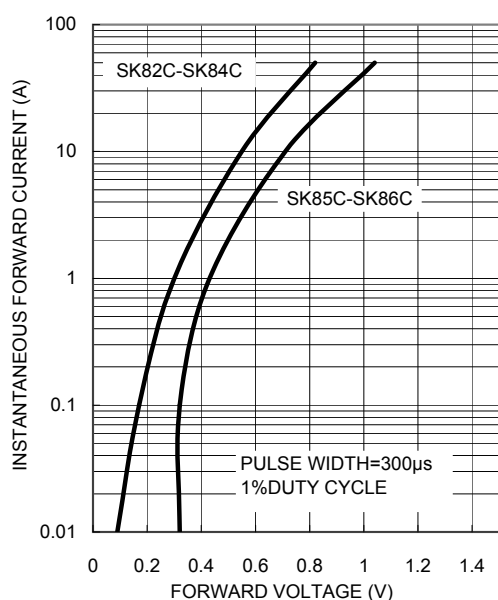


FIG. 4- TYPICAL REVERSE CHARACTERISTICS

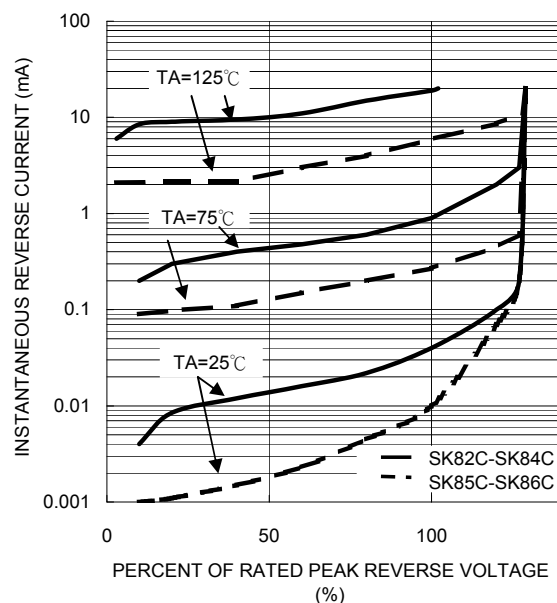


FIG. 5- TYPICAL JUNCTION CAPACITANCE

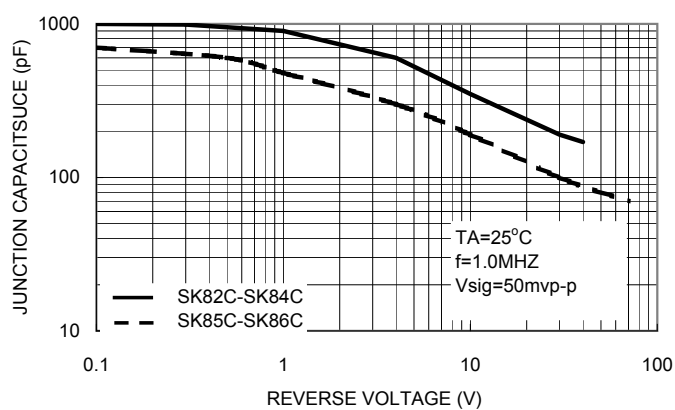


FIG. 6- TYPICAL TRANSIENT THERMAL CHARACTERISTICS

